

August 2008

QEE113

Plastic Infrared Light Emitting Diode

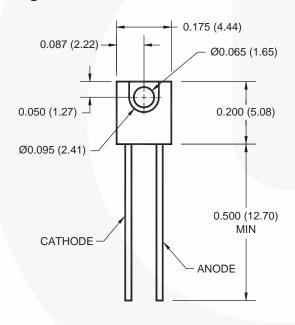
Features

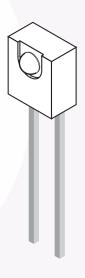
- λ= 940nm
- Package Type = Sidelooker
- Chip Material = GaAs
- Matched Photosensor: QSE113
- Medium Wide Emission Angle, 50°
- Package Material: Clear Epoxy
- High Output Power
- Gray stripe on the top side

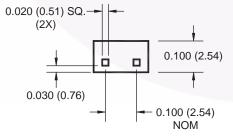
Description

The QEE113 is a 940nm GaAs LED encapsulated in a medium wide angle, plastic sidelooker package.

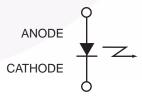
Package Dimensions







Schematic



Notes:

- 1. Dimensions of all drawings are in inches (mm).
- 2. Tolerance is ± 0.010 (0.25) on all non-nominal dimensions unless otherwise specified.

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating	Units
T _{OPR}	Operating Temperature	-40 to +100	C
T _{STG}	Storage Temperature	-40 to +100	C
T _{SOL-I}	Soldering Temperature (Iron) ^(2,3,4)	240 for 5 sec	C
T _{SOL-F}	Soldering Temperature (Flow) ^(2,3)	260 for 10 sec	C
I _F	Continuous Forward Current	50	mA
V _R	Reverse Voltage	5	V
P _D	Power Dissipation ⁽¹⁾	100	mW

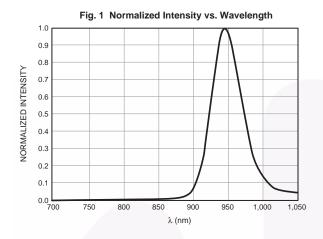
Notes:

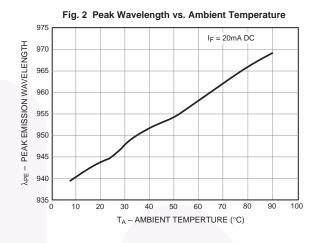
- 1. Derate power dissipation linearly 1.33mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron 1/16" (1.6mm) minimum from housing.

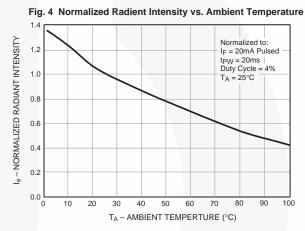
Electrical / Optical Characteristics (T_A = 25°C)

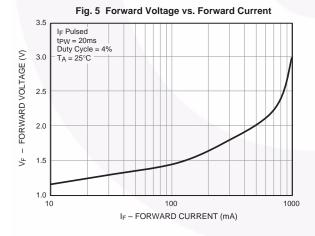
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
λ_{PE}	Peak Emission Wavelength	I _F = 20mA		945		nm
TC_λ	Temperature Coefficient			0.3		nm/℃
2Θ ¹ /2	Emission Angle	I _F = 100mA		50		0
V _F	Forward Voltage	$I_F = 100 \text{mA}, \text{ tp} = 20 \text{ms}$			1.5	V
TC _{VF}	Temperature Coefficient			-2		mV/℃
I _R	Reverse Current	$V_R = 5V$			10	μA
Ι _Ε	Radiant Intensity	$I_F = 100 \text{mA}, \text{ tp} = 20 \text{ms}$	3	7.5	12	mW/sr
TC _{IE}	Temperature Coefficient			-0.7		%/℃
t _r	Rise Time	I _F = 100mA		800		ns
t _f	Fall Time			800		ns
C _j	Junction Capacitance	$V_R = 0V$		14		pF

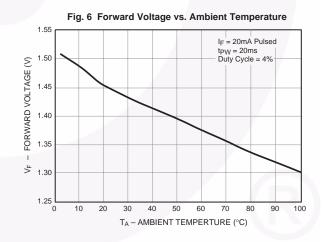
Typical Performance Curves





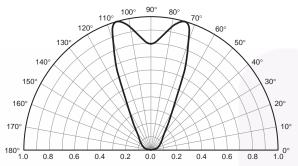


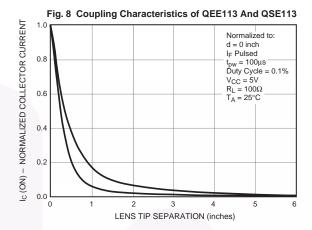




Typical Performance Curves (Continued)

Fig. 7 Radiation Diagram









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